



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
400)/	62mΩ @ V _{GS} = 10V	4A
100V	80mΩ @ V _{GS} = 6V	3.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

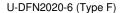
- Power Management Functions
- · Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

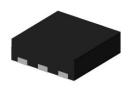
Features and Benefits

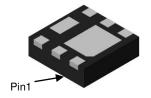
- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low On-Resistance
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

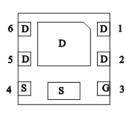
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (Approximate)







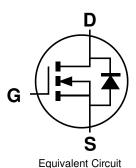
Top View Bottom View



Pin Out

Bottom View





Ordering Information (Note 4)

Part Number	Case	Quantity Per Reel
DMT10H072LFDF-7	U-DFN2020-6 (Type F)	3,000
DMT10H072LFDF-13	U-DFN2020-6 (Type F)	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

U-DFN2020-6 (Type F)



72 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2019	20)20	2021	2022	20)23	2024	2025	20)26	2027
Code	G		Н		J		K	L	M		N	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

U-DFN2020-6 (Type F)



72 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019) W = Week (ex: a = week 27; z represents week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

			2025	2024	2023	2022	2021	2020	2019	Year
Code 9 0 1 2 3 4 5 6	7	6	5	4	3	2	1	0	9	Code

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Υ	Z



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	100	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	$T_A = +25$ °C $T_A = +70$ °C	ΙD	4 3.2	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	22	Α	
Maximum Body Diode Continuous Current	Is	1.6	Α	
Avalanche Current, L = 0.1mH (Note 9)	I _{AS}	6	Α	
Avalanche Energy, L = 0.1mH (Note 9)		E _{AS}	1.8	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dawar Dissination (Note 5)	T _A = +25°C	D	0.8	14/	
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.5	W	
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	149	°C/W	
Total Dawar Dissination (Note 6)	T _A = +25°C	В	1.8	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P _D	1.1	VV	
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	71	°C/W		
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	13	- C/VV		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

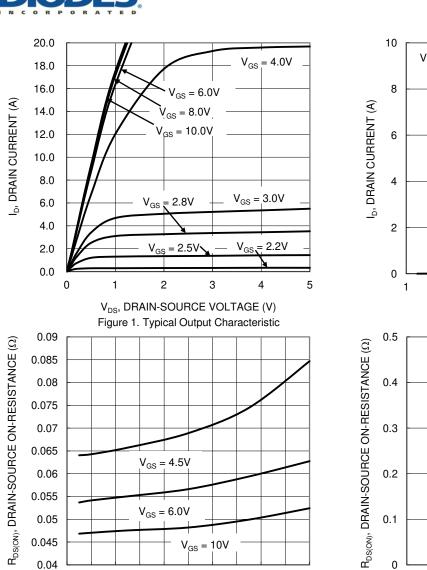
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		_	47	62	mΩ	$V_{GS} = 10V, I_D = 4.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	54	80	11177	$V_{GS} = 6V$, $I_D = 4A$
	, ,	_	64	110	mΩ	$V_{GS} = 4.5V, I_D = 2.6A$
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	$V_{GS} = 0V$, $I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}		228	_	рF	
Output Capacitance	Coss	_	89.3	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ - f = 1MHz
Reverse Transfer Capacitance	Crss	_	2.5	_	pF	T = TIVITZ
Gate Resistance	R_g	_	8.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	2.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	4.5	_	nC	V 50V L 45A
Gate-Source Charge	Q_{gs}	_	0.6	_	nC	$V_{DS} = 50V, I_{D} = 4.5A$
Gate-Drain Charge	Q_{gd}	_	1.3	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	3.0	_	ns	
Turn-On Rise Time	t _R	_	3.1	_	ns	$V_{DS} = 50V, R_{L} = 11\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	12.3	_	ns	$V_{GS} = 10V, R_{GEN} = 3\Omega$
Turn-Off Fall Time	t _F		4.3	_	ns	
Reverse Recovery Time	t _{RR}		22.9	_	ns	1 4 5 4 31/44 2004/
Reverse Recovery Charge	Q _{RR}	_	45.2	_	nC	I _F = 4.5A, di/dt = 300A/μs

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.
- 9. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.





I_D, DRAIN-SOURCE CURRENT (A)
Figure 3. Typical On-Resistance vs. Drain Current and
Gate Voltage

10 12

14 16 18

8

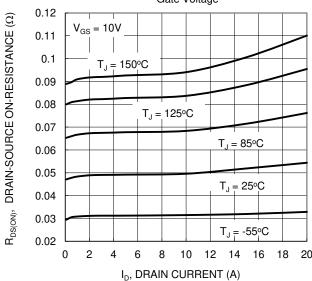


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

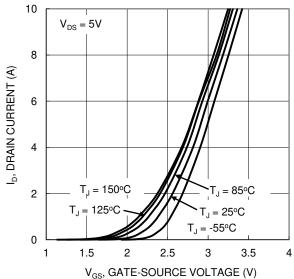


Figure 2. Typical Transfer Characteristic

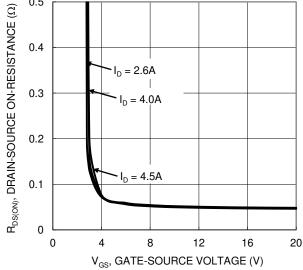


Figure 4. Typical Transfer Characteristic

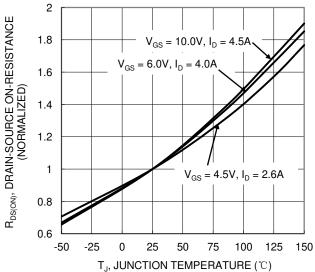
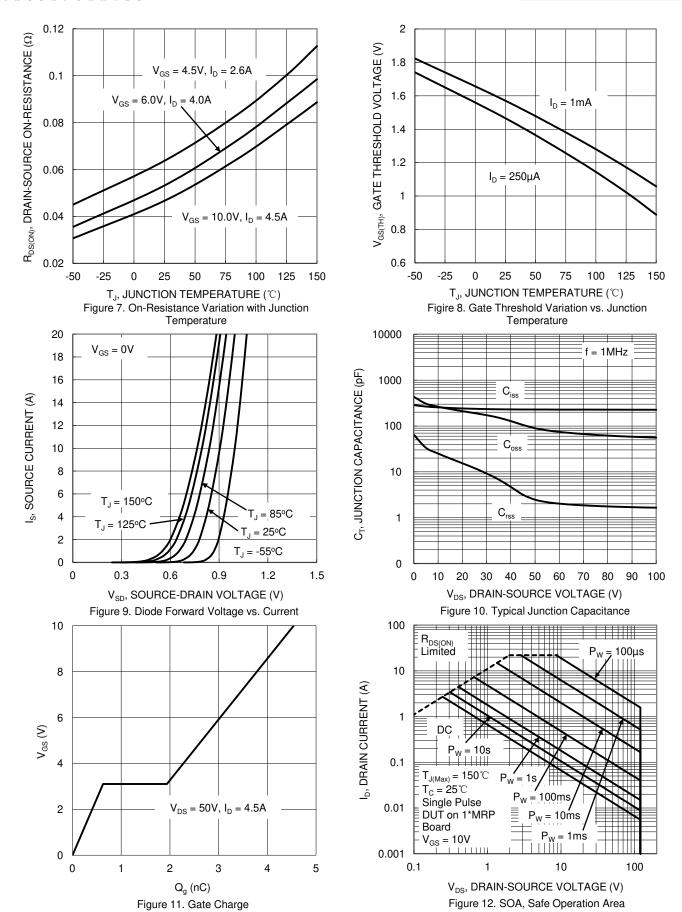


Figure 6. On-Resistance Variation with Junction Temperature







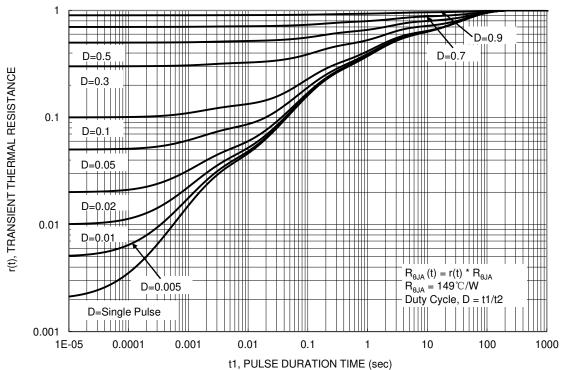


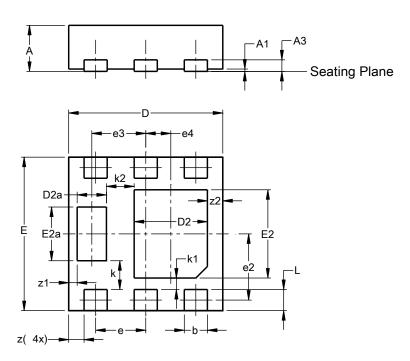
Figure 13. Transient Thermal Resistance



Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

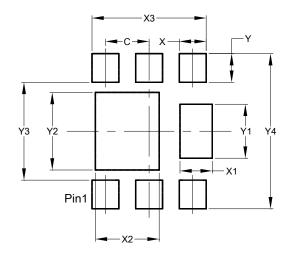


U-DFN2020-6						
	(Typ	oe F)				
Dim	Min	Max	Тур			
Α	0.57	0.63	0.60			
A 1	0.00	0.05	0.03			
А3	-	-	0.15			
b	0.25	0.35	0.30			
D	1.95	2.05	2.00			
D2	0.85 1.05 0.9					
D2a	0.33	0.43	0.38			
Е	1.95	2.05	2.00			
E2	1.05	1.25	1.15			
E2a	0.65 0.75 0.70					
е	0.65 BSC					
e2	0.863 BSC					
e3	0.70 BSC					
e4	0.325 BSC					
k	0.37 BSC					
k1	0.15 BSC					
k2	0.36 BSC					
L	0.225	0.325	0.275			
Z		0.20 BS	С			
z1	().110 BS	SC			
z2		0.20 BS	С			
All C	imens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	value
Difficusions	(in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
Х3	1.700
Υ	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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